## 506199126 08/12/2020

## PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
TAISHI MURAKAMI	07/29/2020
MASAYOSHI DOUI	06/26/2020

#### **RECEIVING PARTY DATA**

Name:	YANMAR POWER TECHNOLOGY CO., LTD.
Street Address:	1-32, CHAYAMACHI
Internal Address:	KITA-KU
City:	OSAKA-KU
State/Country:	JAPAN
Postal Code:	530-0013

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16907563

#### **CORRESPONDENCE DATA**

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Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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ATTORNEY DOCKET NUMBER:	YNM-012CIP
NAME OF SUBMITTER:	CHRIS MIZUMOTO
SIGNATURE:	/Chris Mizumoto/
DATE SIGNED:	08/12/2020

### **Total Attachments: 4**

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PATENT 506199126 REEL: 053463 FRAME: 0866

# Non-Provisional Patent Application Assignment

Docket No.: YNM-012CIP Application No.: 16/907,563 Filed Date: June 22, 2020

Title: Engine

WHEREAS, **Taishi Murakami and Masayoshi Doui**, c/o Yanmar Power Technology Co., Ltd., 1-32. Chayamachi, Kita-ku, Osaka, Japan have invented certain improvements in **Engine**, and described in a patent application filed on **June 22, 2020**, in The United States of America, being owner of and having the right to convey all rights, title, and interests in and to said application and in and to each invention described therein; and

WHEREAS, **Yanmar Power Technology Co., Ltd.,** of 1-32, Chayamachi, Kita-ku, Osaka, Japan, a corporation organized under the laws of Japan and having a mailing address of 1-32, Chayamachi, Kita-ku, Osaka, Japan, (assignee) desires to acquire the entire right, title, and interest in and to said application and said invention described therein and any and all patents to be obtained therefore, all as hereinafter set forth:

NOW, THEREFORE, for good and valuable consideration received by the undersigned, the undersigned hereby sells, assigns, transfers and sets over unto said assignee, its successors and assigns, the entire right, title and interest in and to said invention or inventions, as described in said application, in all forms and embodiments thereof, and in and to the aforesaid application; and in and to any application filed in any foreign country based thereon, including the right to file said foreign applications under the International Convention; also the entire right, title and interest in and to any and all patents or reissues or extensions thereof to be obtained in this or any foreign country upon said invention or inventions and any non-provisional, utility, design, divisional, continuation, continuation-in-part or substitute applications which may be filed upon said invention or inventions in this or any foreign country; and the undersigned hereby authorizes and requests the issuing authority to issue any and all patents on said application or applications to said assignee or its successors and assigns.

The undersigned further agrees to execute and deliver all non- provisional, utility, design, divisional, continuing, substitute, improvement, extension, reissue and other patent applications in this or any foreign country relating to said application or invention and to sign all other lawful papers and to perform all other lawful acts without further consideration, subject to reimbursement of out-of-pocket expenses approved by assignee in advance in writing, which the assignee may deem necessary or desirable to make this Assignment fully effective, including by way of example, but not of limitation, the following acts:

- (1) Prompt execution of all lawful oaths, affidavits and/or supplemental oaths required or deemed advisable by the assignee to further the prosecution of any application or applications for letters patent relating to the subject matter of this Assignment; and
- (2) Cooperation to the best of my ability in the execution of all lawful documents, the production of evidence, and the giving of testimony in interference, opposition, nullification or infringement proceedings involving any of said invention or improvement, applications or

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patents.		
IN WITNESS WHEREOF, the set after his signature.	undersigned has hereunto set his/her hand and seal on the	date
払上だら Taishi Murakami	Date: 2020年7月29日	
Masayoshi Doul	Date:	

# Non-Provisional Patent Application Assignment

Docket No.: YNM-012CIP Application No.: 16/907,563 Filed Date: June 22, 2020

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WHEREAS, Yanmar Power Technology Co., Ltd., of 1-32, Chayamachi, Kita-ku, Osaka, Japan, a corporation organized under the laws of Japan and having a mailing address of 1-32, Chayamachi, Kita-ku, Osaka, Japan, (assignee) desires to acquire the entire right, title, and interest in and to said application and said invention described therein and any and all patents to be obtained therefore, all as hereinafter set forth:

NOW, THEREFORE, for good and valuable consideration received by the undersigned, the undersigned hereby sells, assigns, transfers and sets over unto said assignee, its successors and assigns, the entire right, title and interest in and to said invention or inventions, as described in said application, in all forms and embodiments thereof, and in and to the aforesaid application; and in and to any application filed in any foreign country based thereon, including the right to file said foreign applications under the International Convention; also the entire right, title and interest in and to any and all patents or reissues or extensions thereof to be obtained in this or any foreign country upon said invention or inventions and any non-provisional, utility, design, divisional, continuation, continuation-in-part or substitute applications which may be filed upon said invention or inventions in this or any foreign country; and the undersigned hereby authorizes and requests the issuing authority to issue any and all patents on said application or applications to said assignee or its successors and lassigns.

The undersigned further agrees to execute and deliver all non- provisional, utility, design, divisional, continuing, substitute, improvement, extension, reissue and other patent applications in this or any foreign country relating to said application or invention and to sign all other lawful papers and to perform all other lawful acts without further consideration, subject to reimbursement of out-of-pocket expenses approved by assignee in advance in writing, which the assignee may deem necessary or desirable to make this Assignment fully reflective, including by way of example, but not of limitation, the following acts:

- (1) Prompt execution of all lawful oaths, affidavits and/or supplemental oaths required or deemed advisable by the assignee to further the prosecution of any application or applications for letters patent relating to the subject matter of this Assignment; and
- (2) Cooperation to the best of my ability in the execution of all lawful documents, the production of evidence, and the giving of testimony in interference, opposition, nullification or infrincement proceedings involving any of said invention or improvement, applications or

Taishi Murakemi	Date:	
引才 正教	Date: 2020. 6.26	
Masayoshi Doui		